



Qualcomm Technologies,
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www.qualcomm.com

Date: November 6, 2024

To: **SGS-CSTC Standards Technical Services (Shanghai) Co., Ltd.**
No. 588 West Jindu Road, Songjiang District, Shanghai, China. 201612

Dear Sir/Madam,
Subject: **Declaration Letter about Identity of Products**

*WE [Qualcomm Technologies, Inc.](#) HEREBY DECLARED THAT

Our product:

Product Description:	Tri-Radio LGA Module for IoT applications
Model No.:	QCC744M-0
HVIN:	QCC744M-0B, QCC744M-0U, QCC748M-0B, QCC748M-0U
Manufacturer's Name:	Qualcomm Technologies, Inc.
Manufacturer's Address:	5775 Morehouse Drive, San Diego, CA 92121 USA

The model QCC744M-0 has four HW SKU: QCC744M-0B, QCC744M-0U, QCC748M-0B, QCC748M-0U, their differences are mentioned in below table, while the other parts are completely identical. Based on the differences, complete testing was conducted for QCC744M-0U (Only complete RSE testing for different antennas).

Differences Table:

HVIN	Antenna Type	Impedance	Chip Design
QCC744M-0U	3 types: PIFA, Monopole, Dipole	C21=1.86pF, C20=1.89pF	Does not support USB pinout
QCC744M-0B	1 type: PCB	C21=1.52pF C20=2.05pF	Does not support USB pinout
QCC748M-0U	3 types: PIFA, Monopole, Dipole	C21=1.86pF, C20=1.89pF	Support USB pinout
QCC748M-0B	1 type: PCB	C21=1.52pF C20=2.05pF	Support USB pinout

Sincerely,

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